PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
Da-Yuan LEE	07/23/2009
Jian-Hao CHEN	07/23/2009
Chi-Chun CHEN	10/29/2009
Matt YEH	07/23/2009
Hsing-Jui LEE	07/23/2009

RECEIVING PARTY DATA

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.		
Street Address:	No. 8, Li-Hsin Rd. 6 Science-Based Industrial Park		
Internal Address:			
City:	Hsin-Chu		
State/Country:	TAIWAN		
Postal Code:	300-77		

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12567227

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 24061.1120

> **PATENT REEL: 023650 FRAME: 0686**

NAME OF SUBMITTER:	David M. O'Dell
Total Attachments: 4 source=1120_assignment#page1.tif source=1120_assignment#page2.tif source=1120_assignment#page3.tif source=1120_assignment#page4.tif	

PATENT REEL: 023650 FRAME: 0687

Docket No.: 2008-0626 (2008-0666) / 24061.1120

Customer No.: 42717

ASSIGNMENT

WH	ER	EA	S.	we.

(1)	Da-Yuan Lee	of	10F, No. 172, Sec. 2, Jiafong S. Road Jhubei City, Hsinchu County 302, Taiwan, R.O.C.
(2)	Jian-Hao Chen	of	9F-2, No. 21, Lane 23, Guandong Road, East District Hsinchu City 300, Taiwan, R.O.C.
(3)	Chi-Chun Chen	of	8F, No. 56, ChangSheng Road, Gushan Chiu Kaohsiung, Taiwan, R.O.C.
(4)	Matt Yeh	of	6F, 6, Ching-San Street 28 Hsinchun, Taiwan, R.O.C.
(5)	Hsing-Jui Lee	of	No. 17, Jinshan E. 3rd Street, East District Hsinchu City 300, Taiwan, R.O.C.

have invented certain improvements in

FABRICATING HIGH-K/METAL GATE DEVICES IN A GATE LAST PROCESS

for which we have executed an application for Letters Patent of the United States of America,

	of even date filed herewith; and	
XX	filed on September 25, 2009 and assigned application no.	12/567,227 and

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China. is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid,

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to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor Name:

Da-Yuan Lee

Residence Address:

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Jhubei City, Hsinchu County 302, Taiwan, R.O.C.

Dated: 2009, 07, 23

Da Yvar Lee Inventor Signature

Inventor Name:

Jian-Hao Chen

Residence Address:

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Hsinchu City 300, Taiwan, R.O.C.

Dated:

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Jan - How Chen

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Inventor Name:	Chi-Chun Chen			
Residence Address:	8F, No. 56, ChangSheng Road Kaohsiung, Taiwan, R.O.C.	Gushan Chiu		
Dated: (0-29	-09	Inventor Signature		
Inventor Name:	Matt Yeh			
Residence Address:	6F, 6, Ching-San Street 28 Hsinchun, Taiwan, R.O.C.			
Dated:		Inventor Signature		
Inventor Name:	Hsing-Jui Lee			
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Dated:				
		Inventor Signature		

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